

**REQUIREMENT FOR BOND RELEASE OR BOND REDUCTION
FROM ENGINEERING DIVISION**

Prior to Bond Release, an As-Built must be on file with Township Engineer.

Plan must be prepared, signed and sealed by a licensed Land Surveyor. As-Built plan shall include site, monumentation, subdivision, sanitary sewer, storm, detention basin, lighting, etc...

Applicant shall submit a paper copy for review and approval by the Engineering office. Once approved by Engineering applicant shall send in mylar (1 copy), paper prints (6 copies) and CD (1 copy- Auto-Cad version not later than 2005). All plans and CDs shall be submitted to Land Use.

Prior to Bond Reduction an Engineer Estimate signed and sealed by a licensed Engineer showing all work completed and all work outstanding will need to be submitted and reviewed.

Should you have any questions call Engineering office at 609-890-3635